

#### TOSHIBA BiCD Integrated Circuit Silicon Monolithic

# TB5128: H;

#### **CLOCK-in and Serial controlled Bipolar Stepping Motor Driver**

#### 1. Outline

The TB5128FTG is a two-phase bipolar stepping motor driver using a PWM chopper. The clock in decoder is built in.

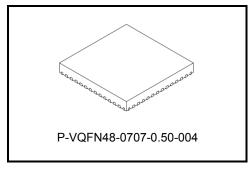
Fabricated with the BiCD process, output rating is 50 V/5.0 A (Motor supply voltage = 44 V).

#### 2. Features

- BiCD process integrated monolithic IC.
- Capable of controlling 1 bipolar stepping motor.
- PWM controlled constant-current drive
- Low on resistance (High + Low side = 0.25 Ω (typ.))
   MOSFET output stage.
- Allows full, half, quarter, 1/8, 1/16, 1/32, 1/64, 1/128 step operation.
- High efficiency motor current control mechanism (ADMD: Advanced Dynamic Mixed Decay)
- Built-in Sense resistor less current control architecture (ACDS: Advanced Current Detection System)
- High voltage and current (For specification, please refer to absolute maximum ratings and operation ranges)
- Multi error detect functions (Thermal shutdown (TSD), Over current (ISD), Power-on-reset (POR), motor load open (OPD)).
- Error detection (TSD/ISD/OPD) flag output function
- Built-in VCC regulator for internal circuit
- Chopping frequency of a motor can be adjusted by external resistance and capacitor.
- Small package with thermal pad

TB5128FTG: P-VQFN48-0707-0.50-004

Note: Please be careful about thermal conditions during using.

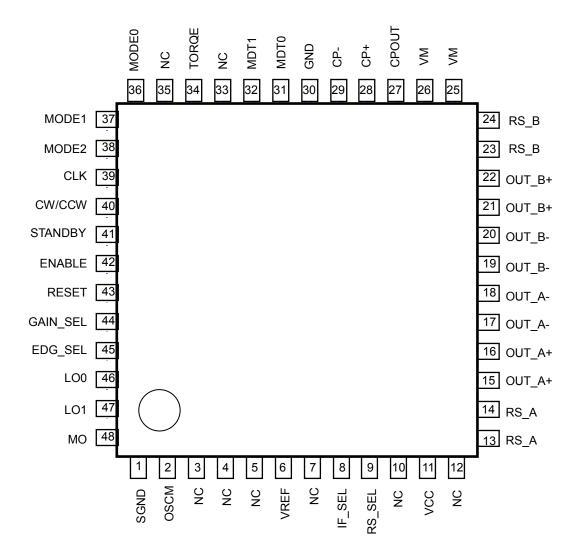


Weight: 0.14g (typ.)

## 3. Pin Assignment

Pin assignment in CLK mode (IF\_SEL pin = L) is shown in below figure.

<TOP View>



Note: Please solder the corner pad and the rear thermal pad of the QFN package, to the GND pattern of the PCB.

## 4. Pin Description

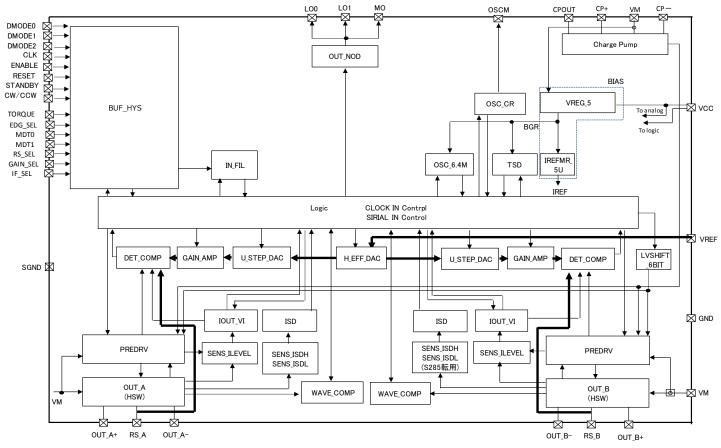
5: 11	Symbo	ol	D			
Pin No.	CLK mode	Serial mode	Description			
1	SGND	SGND	Logic ground pin			
2	OSCM	OSCM	Internal oscillator frequency monitor and setting pin			
3	NC	NC	NC Pin			
4	NC	NC	NC Pin			
5	NC	NC	NC Pin			
6	VREF	VREF	Current threshold reference pin			
7	NC	NC	NC Pin			
8	IF_SEL	IF_SEL	Interface select pin			
9	RS_SEL	NC	RS mode select pin			
10	NC	NC	NC pin			
11	VCC	VCC	Internal regulator voltage monitor pin			
12	NC	NC	NC pin			
13	RS_A (Note2)	RS_A (Note2)	Ach current sense resistor connected pin / Ach motor power ground pin			
14	RS_A (Note2)	RS_A (Note2)	Ach current sense resistor connected pin / Ach motor power ground pin			
15	OUT_A+ (Note2)	OUT_A+ (Note2)	Ach motor output(+) pin			
16	OUT_A+ (Note2)	OUT_A+ (Note2)	Ach motor output(+) pin			
17	OUT_A- (Note2)	OUT_A- (Note2)	Ach motor output(-) pin			
18	OUT_A- (Note2)	OUT_A- (Note2)	Ach motor output(-) pin			
19	OUT_B- (Note2)	OUT_B- (Note2)	Bch motor output(-) pin			
20	OUT_B- (Note2)	OUT_B- (Note2)	Bch motor output(-) pin			
21	OUT_B+ (Note2)	OUT_B+ (Note2)	Bch motor output(+) pin			
22	OUT_B+ (Note2)	OUT_B+ (Note2)	Bch motor output(+) pin			
23	DS D (Noto2)	DS P (Noto2)	Bch current sense resistor connected pin /			
23	RS_B (Note2)	RS_B (Note2)	Bch motor power ground pin			
24	RS_B (Note2)	RS_B (Note2)	Bch current sense resistor connected pin / Bch motor power ground pin			
25	VM (Note2)	VM (Note2)	Motor power supply input pin			
26	VM (Note2)	VM (Note2)	Motor power supply input pin			
27	CPOUT	CPOUT	Pin for Charge pump			
28	CP+	CP+	Pin for Charge pump			
29	CP-	CP-	Pin for Charge pump			
30	GND	GND	GND			
31	MDT0	NC	Mixed Decay/ADMD setting pin			
32	MDT1	NC	Mixed Decay/ADMD setting pin			
33	NC	NC	NC pin			
34	TORQE	NC	Torque setting pin			
35	NC	NC	NC pin			
36	MODE0	NC	Excitation setting pin No.0			
37	MODE1	NC	Excitation setting pin No.1			
38	MODE2	NC	Excitation setting pin No.2			
39	CLK	CLK	Step clock input pin / Serial clock input pin			
40	CW/CCW	DATA	Current direction setup pin / Data input pin in serial interface			
41	STANDBY	STANDBY	Standby pin			
42	ENABLE	LATCH	Motor output ON/OFF pin / Latch Enable input pin			
43	RESET	BANK_EN	Electrical angle initialize pin / BANK select pin			

Die Ne	Symbo	ol	Description			
Pin No.	CLK mode	Serial mode				
44	GAIN_SEL	NC	Vref Gain setting pin			
45	EDG_SEL	NC	CLK edge setting pin			
46	LO0	LO0	Error detection flag output pin No.0			
47	LO1	LO1	Error detection flag output pin No.1			
48	MO	NC	Electrical angle monitor pin			

Note1: This pin should be opened or connected to Ground.

Note2: The same name pins should be connected with PCB pattern each other.

## 5. Block Diagram

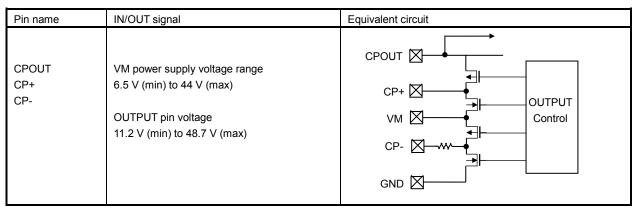


Note: Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purpose.

Note: All the grounding wires of the TB5128 should run on the solder mask on the PCB and be externally terminated at only one point. Also, a grounding method should be considered for efficient heat dissipation. Careful attention should be paid to the layout of the output, VM and GND traces, to avoid short circuits across output pins or to the power supply or ground. If such a short circuit occurs, the device may be permanently damaged. Also, the utmost care should be taken for pattern designing and implementation of the device since it has power supply pins (VM, RS line, OUT line, and GND) through which a particularly large current may run. If these pins are wired incorrectly, an operation error may occur or the device may be destroyed. The logic input pins must also be wired correctly. Otherwise, the device may be damaged owing to a current running through the IC that is larger than the specified current. Careful attention should be paid to design patterns and mountings.

# 6. INPUT/OUTPUT Equivalent Circuit

Pin name	IN/OUT signal	Equivalent circuit
MODE0, 1, 2 CLK ENABLE RESET CW/CCW TORQE EDG_SEL MDT0, 1 RS_SEL GAIN_SEL IF_SEL STANDBY	Digital Input (VIH/VIL)  VIH: 2.0 V (min) to 5.5 V (max)  VIL: 0 V (min) to 0.8 V (max)	Logic input pin CY OO THE STATE OF THE STAT
LO0, LO1 MO	Digital Output (VOH/VOL) (Pullup resistance:10 k to 100 k $\Omega$ )	Logic Output Pin
VCC	VCC voltage range 4.75 V (min) 5.0 V (typ.) 5.25 V (max)  VREF voltage range 0 V to 3.6 V	VCC UNREF UNIT 1 kΩ
OSCM	OSCM frequency setting range 0.64 MHz (min) 1.12 MHz (typ.) 2.4 MHz (max)	OSCM The state of
OUT_A+ OUT_A- OUT_B+ OUT_B- RS_A RS_B	VM power supply voltage range 6.5 V (min) to 44 V (max) OUTPUT pin voltage 11.2 V (min) to 48.7 V (max)	OUT_x+  GND  RS_x  X = A or B



Note: The equivalent circuit diagrams may be simplified for explanatory purposes.

#### 7. IF Select Function

IF can be selected from CLK type or serial type.

IF_SEL pin input	Function
L	CLK mode
Н	Serial mode

## 8. Functional Description 1 (for CLK mode when IF\_SEL pin = L)

#### 8.1. CLK Function

Each up-edge of the CLK signal will shift the motor's electrical angle per step.

When EDG\_SEL pin = L (Single Edge)

CLK pin input	Function
Up-edge	Shifts the electrical angle per step.
Down-edge	(State of the electrical angle does not change.)

When  $EDG\_SEL$  pin = H (Double Edge)

CLK pin input	Function
Up-edge	Shifts the electrical angle per step.
Down-edge	Shifts the electrical angle per step.

#### 8.2. ENABLE Function

The ENABLE pin controls the ON and OFF of the stepping motor outputs. Motor operation starts and stops by setting H and L to the ENABLE pin. (When ENABLE pin is set to L (OFF), all of the MOSFETs turn off and become high impedance (hereafter, Hi-Z).)

Setting the ENABLE pin to L, and avoiding the motor to operate during VM power-on and power-off (i.e., outside of the operating voltage range) is recommended. Then, switch the ENABLE pin to H after the VM reaches the target voltage and becomes stable.

ENABLE pin input	Function
L	OFF (High impedance mode, later omitted Hi-Z mode later)
Н	ON (Normal operation mode)

# 8.3. CW/CCW Function and the Output Pin Function (Output logic at the time of a charge start)

The CW/CCW pin controls the rotation direction of the motor. When set to H, the current of OUT\_A is output first, with a phase difference of 90°. When set to L, the current of OUT\_B is output first with a phase difference of 90°.

CW/CCW pin input	OUT_x+	OUT_x-
L: Counter clockwise operation (CCW)	L	Н
H: Clockwise operation (CW)	Н	L

Note: x = A or B

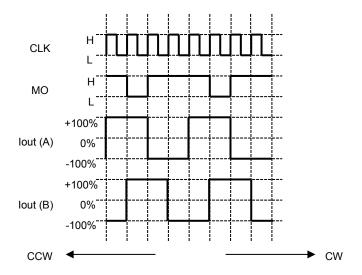
#### 8.4. Step Resolution Select Function

MODE 0, MODE1, and MODE2 pins control the step resolution. Pin levels of MODE0, MODE1, and MODE2 can be switched during operation. The following step current depends on the electrical angle.

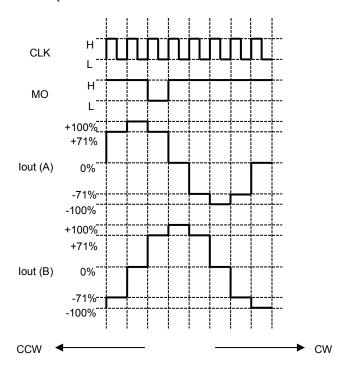
MODE2 pin input	MODE1 pin input	MODE0 pin input	Function
L	L	L	Full step resolution
L	L	Н	Half step resolution
L	Н	L	Quarter step resolution
L	Н	Н	1/8 step resolution
Н	L	L	1/16 step resolution
Н	L	Н	1/32 step resolution
Н	Н	L	1/64 step resolution
Н	Н	Н	1/128 step resolution

## 8.5. Timing Chart of Step Resolution Setting and Initial Angel

[Full step resolution]



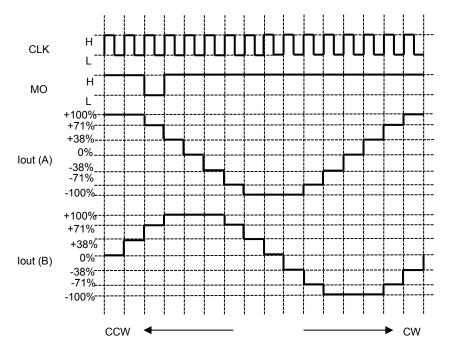
[Half step resolution]



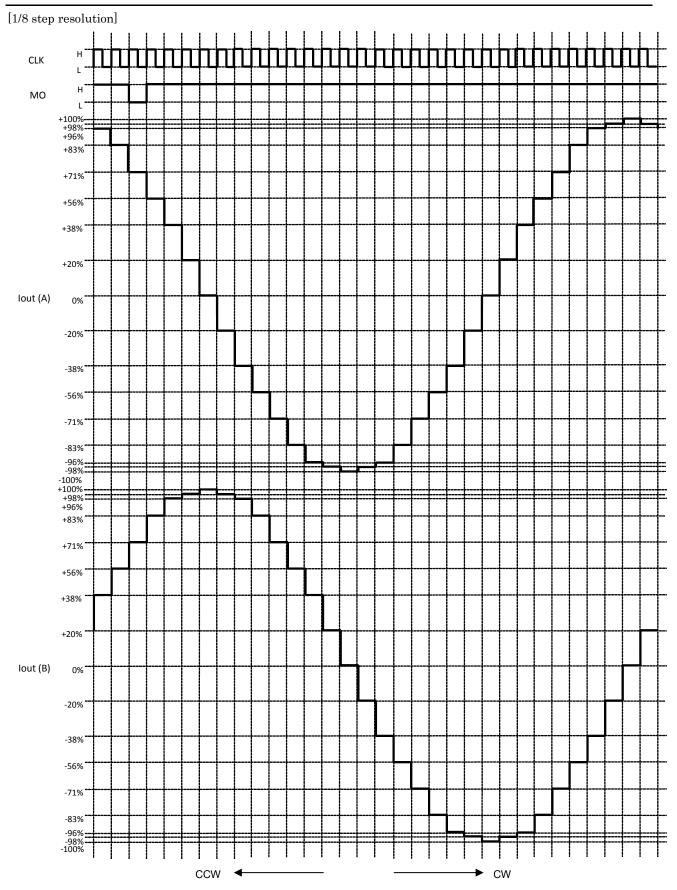
Note: MO signal is shown in the above timing chart when MO pin is connected with a pull-up resistor to VCC.

Note: Timing charts may be simplified for explanatory purpose.

#### [Quarter step resolution]

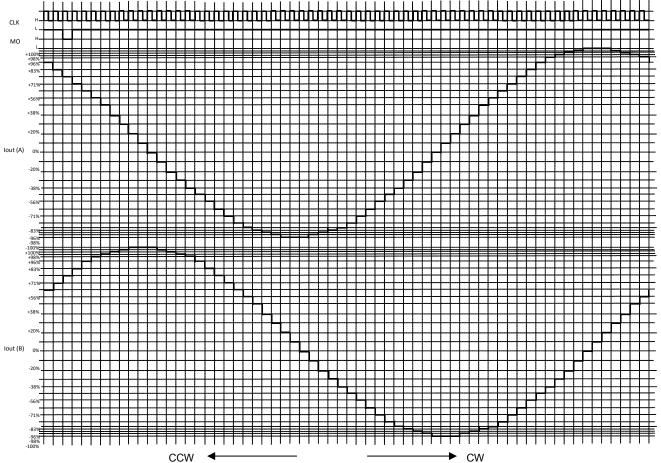


Note: MO signal is shown in the above timing chart when MO pin is connected with a pull-up resistor to VCC. Note: Timing charts may be simplified for explanatory purpose.



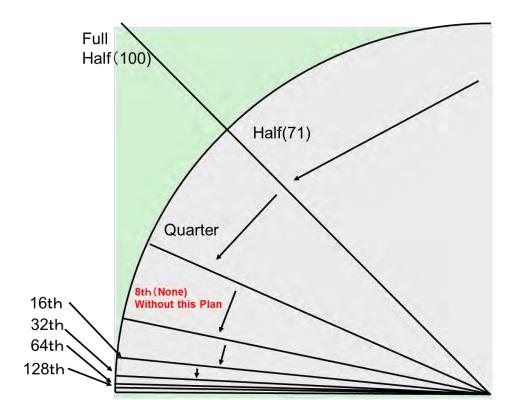
Note: MO signal is shown in the above timing chart when MO pin is connected with a pull-up resistor to VCC. Note: Timing charts may be simplified for explanatory purpose.

[1/16 step resolution]



Note: MO signal is shown in the above timing chart when MO pin is connected with a pull-up resistor to VCC.

Note: Timing charts may be simplified for explanatory purpose.



## 8.6. Step Setting and Current Percentage

Current (%)	Full	Half	Quarter	1/8	1/16	1/32	1/64	1/128
100%	Available	Available	Available	Available	Available	Available	Available	Available
99%	, wallable	/ wallable	/ wallable	/ wallable	Available	Available	Available	Available
98%				Available	Available	Available	Available	Available
98%				, wanabid	Available	Available	Available	Available
96%				Available	Available	Available	Available	Available
95%							Available	Available
94%						Available	Available	Available
93%							Available	Available
92%						Available	Available	Available
91%							Available	Available
90%					Available	Available	Available	Available
89%							Available	Available
88%						Available	Available	Available
87%							Available	Available
86%						Available	Available	Available
85%								Available
84%							Available	Available
83%				Available	Available	Available	Available	Available
82%							Available	Available
81%								Available
80%						Available	Available	Available
79%							Available	Available
78%								Available
77%					Available	Available	Available	Available
76%							Available	Available
75%							_	Available
74%						Available	Available	Available
73%								Available
72%							Available	Available
71%		Available	Available	Available	Available	Available	Available	Available
70%								Available
69%							Available	Available
68%								Available
67%						Available	Available	Available
66%								Available
65%							Available	Available
64%								Available
63%					Available	Available	Available	Available
62%							Available	Available
61%								Available
60%						Available	Available	Available
59%								Available
58%							Available	Available
57%								Available
56%				Available	Available	Available	Available	Available
55%								Available
53%						_	Available	Available
52%						Available		Available
51%							Available	Available
50%					<u> </u>		_	Available
49%					<u> </u>		Available	Available
48%						_		Available
47%					Available	Available	Available	Available
46%								Available

Current (%)	Full	Half	Quarter	1/8	1/16	1/32	1/64	1/128
45%							Available	Available
44%								Available
43%						Available	Available	Available
42%								Available
41%							Available	Available
39%								Available
38%			Available	Available	Available	Available	Available	Available
37%								Available
36%							Available	Available
35%								Available
34%						Available	Available	Available
33%								Available
31%							Available	Available
30%								Available
29%					Available	Available	Available	Available
28%								Available
27%							Available	Available
25%						Available		Available
24%							Available	Available
23%								Available
22%							Available	Available
21%								Available
20%				Available	Available	Available	Available	Available
18%								Available
17%							Available	Available
16%								Available
15%						Available	Available	Available
13%								Available
12%							Available	Available
11%								Available
10%					Available	Available	Available	Available
9%								Available
7%							Available	Available
6%								Available
5%						Available	Available	Available
4%								Available
2%							Available	Available
1%								Available
0%		Available						

## 8.7. Step Resolution and Set Current

Ach	STEP	1/1	28	1/	64	1/3	32	1/	16	1.	/8	1.	/4	1	/2	F	ull
100   100	_																
e1         100         1         0         2         100         2         100         2         100         2         100         2         100         2         100         2         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         1         100         10         100         1																(%)	(%)
92				100	0	100		100	0	100		100	0	100			
63				100	2												
94				100													
Be				400		100											
B6				100	5	100	b										
97   100   9				400	7												
68         100         10         100         10         100         10         100         10         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10         100         10				100	/												
09				400		400	- 10	400	4.0								
010         99         12         99         12         99         12         99         12         99         13         99         13         99         15         99         16         99         18         99         18         99         18         99         18         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98				100	10	100	10	100	10								
011         99         13         012         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         16         99         17         99         17         99         17         99         17         99         17         99         17         99         17         99         17         99         17         99         17         99         17         99         17         99         17         99         18         99         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         20         98         2																	
012         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         15         99         16         98         20         98				99	12												
013         99         16         0 <td></td>																	
614         99         17         99         17	θ12	99	15	99	15	99	15										
615         98         18         0 <td>θ13</td> <td>99</td> <td>16</td> <td></td>	θ13	99	16														
016         98         20         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98	θ14	99	17	99	17												
617         98         21         0 <td>θ15</td> <td>98</td> <td>18</td> <td></td>	θ15	98	18														
018         98         22         98         22	θ16	98	20	98	20	98	20	98	20	98	20						
019         97         23	θ17	98	21														
620         97         24         97         97         24         97         97         97         98         29         98         99         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         98         29         38         98         38         98         34         94         34         94         34	θ18	98	22	98	22												
621       97       25	θ19	97	23														
622       96       27       96       27         623       96       28       96       29       96       29       96       29         624       96       29       98       29       38       92       38       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92       38       92	θ20	97	24	97	24	97	24										
923       96       28   <td>θ21</td> <td>97</td> <td>25</td> <td></td>	θ21	97	25														
024       96       29       96       29       96       29       96       29       96       29       96       29       96       29       96       29       96       29       98       29       98       29       98       29       98       29       98       29       98       29       98       29       98       29       98       29       98       29       31       90       90       29       30       90       30 <t< td=""><td>θ22</td><td>96</td><td>27</td><td>96</td><td>27</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></t<>	θ22	96	27	96	27												
625       95       30   <td>θ23</td> <td>96</td> <td>28</td> <td></td>	θ23	96	28														
026       95       31       95       31         027       95       33       33       34	θ24	96	29	96	29	96	29	96	29								
027       95       33   <td>θ25</td> <td>95</td> <td>30</td> <td></td>	θ25	95	30														
028       94       34       94       34       94       34       94       34       94       34       94       34       94       34       94       34       94       34       94       34       92       92       94       35       92       92       92       38       93       93       94       93       93       93       94 <t< td=""><td>θ26</td><td>95</td><td>31</td><td>95</td><td>31</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></t<>	θ26	95	31	95	31												
029       94       35       35       35       35       36       36       36       36       36       36       36       36       36       37 <t< td=""><td>θ27</td><td>95</td><td>33</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></t<>	θ27	95	33														
030     93     36     93     36       031     93     37     37       032     92     38     92	θ28	94	34	94	34	94	34										
831     93     37       832     92     38	θ29	94	35														
032     92     38	θ30	93	36	93	36												
θ33 92 39	θ31	93	37														
θ33 92 39	θ32	92	38	92	38	92	38	92	38	92	38	92	38				
834 91 41 91 41	θ33	92	39														
	θ34	91	41	91	41												

STEP	1/1	28	1/0	64	1/3	32	1/	16	1.	/8	1.	/4	1,	/2	F	ull
_	Ach (%)	Bch (%)	Ach (%)	Bch (%)	Ach (%)	Bch (%)	Ach (%)	Bch (%)	Ach (%)	Bch (%)	Ach (%)	Bch (%)	Ach (%)	Bch (%)	Ach (%)	Bch (%)
θ35	91	42														
θ36	90	43	90	43	90	43										
θ37	90	44														
θ38	89	45	89	45												
θ39	89	46														
θ40	88	47	88	47	88	47	88	47								
θ41	88	48														
θ42	87	49	87	49												
θ43	86	50														
θ44	86	51	86	51	86	51										
θ45	85	52														
046	84	53	84	53												
θ47	84	55														
048	83	56	83	56	83	56	83	56	83	56						
049	82	57														
<del>0</del> 50	82	58	82	58												
θ51	81	59														
θ52	80	60	80	60	80	60										
θ53	80	61														
θ54	79	62	79	62												
θ55	78	62														
<del>0</del> 56	77	63	77	63	77	63	77	63								
057	77	64														
θ58	76	65	76	65												
059	75	66														
θ60	74	67	74	67	74	67										
θ61	73	68														
θ62	72	69	72	69												
θ63	72	70														
θ64	71	71	71	71	71	71	71	71	71	71	71	71	71	71	100	100
θ65	70	72														
966	69	72	69	72												
967	68	73														
θ68	67	74	67	74	67	74										
θ69	66	75														
θ70	65	76	65	76												

STEP	1/1	28	1/0	64	1/3	32	1/	16	1.	/8	1.	/4	1,	/2	Fı	ull
_	Ach (%)	Bch (%)														
θ71	64	77	,		, ,	, ,		,		, ,	, ,	, ,	, ,	, ,	, ,	
θ72	63	77	63	77	63	77	63	77								
θ73	62	78														
θ74	62	79	62	79												
θ75	61	80														
θ76	60	80	60	80	60	80										
θ77	59	81														
θ78	58	82	58	82												
θ79	57	82														
θ80	56	83	56	83	56	83	56	83	56	83						
θ81	55	84														
θ82	53	84	53	84												
θ83	52	85														
θ84	51	86	51	86	51	86										
θ85	50	86														
θ86	49	87	49	87												
θ87	48	88														
θ88	47	88	47	88	47	88	47	88								
θ89	46	89														
θ90	45	89	45	89												
θ91	44	90														
θ92	43	90	43	90	43	90										
θ93	42	91														
094	41	91	41	91												
θ95	39	92														
096	38	92	38	92	38	92	38	92	38	92	38	92				
097	37	93														
098	36	93	36	93												
099	35	94														
θ100	34	94	34	94	34	94										
θ101	33	95														
θ102	31	95	31	95												
θ103	30	95														
θ104	29	96	29	96	29	96	29	96								
θ105	28	96														
θ106	27	96	27	96												

STEP	1/1	28	1/0	64	1/3	32	1/	16	1.	/8	1,	/4	1,	/2	F	ull
_	Ach (%)	Bch (%)														
θ107	25	97		, ,	, ,	, ,	, ,	, ,	, ,		, ,	, ,	, ,	, ,	, ,	
θ108	24	97	24	97	24	97										
θ109	23	97														
θ110	22	98	22	98												
θ111	21	98														
θ112	20	98	20	98	20	98	20	98	20	98						
θ113	18	98														
θ114	17	99	17	99												
θ115	16	99														
θ116	15	99	15	99	15	99										
θ117	13	99														
θ118	12	99	12	99												
θ119	11	99														
θ120	10	100	10	100	10	100	10	100								
θ121	9	100														
θ122	7	100	7	100												
θ123	6	100														
θ124	5	100	5	100	5	100										
θ125	4	100														
θ126	2	100	2	100												
θ127	1	100														
θ128	0	100	0	100	0	100	0	100	0	100	0	100	0	100		

#### 8.8. RESET Function

The RESET pin initializes the internal electrical angle.

RESET pin input	Function
L	Normal operation mode
Н	Sets the electrical angle to the initial condition.

Note: Digital filter of 0.625 µs (±20 %) is implemented to the RESET pin.

The current for each channel (while RESET pin is applied) is shown in the table below. MO pin will show L at this time.

Step resolution setting	Ach current setting	Bch current setting	Default electrical angle
Full step	100%	100%	45°
Half step	71%	71%	45°
Quarter step	71%	71%	45°
1/8 step	71%	71%	45°
1/16 step	71%	71%	45°
1/32 step	71%	71%	45°
1/64 step	71%	71%	45°
1/128 step	71%	71%	45°

## 8.9. Torque Function

By using this pin it is possible to switch the motor torque setting.

TORQE	Function
L	Set torque: 100%
Н	Set torque: 50%

## 8.10. CLK Edge Function

CLK edge function can be selected the CLK signal's rising edge or the CLK edge's dual (up and down).

EDG_SEL pin input	Function
L	Single edge (Only Up Edge of CLK Signal)
Н	Dual edge (Up and Down edge)

#### 8.11. RS Function

RS function can be selected either ACDS mode or external sense RS resistor mode.

RS_SEL pin input	Function
L	ACDS (RS resistor less) mode
Н	External sense RS resistor mode

Note: PCB board should be designed according to RS Function.

#### 8.12. Gain Function

Gain function can be change Vref(gain). Vref(gain) can be selected either 1/5 or 1/10.

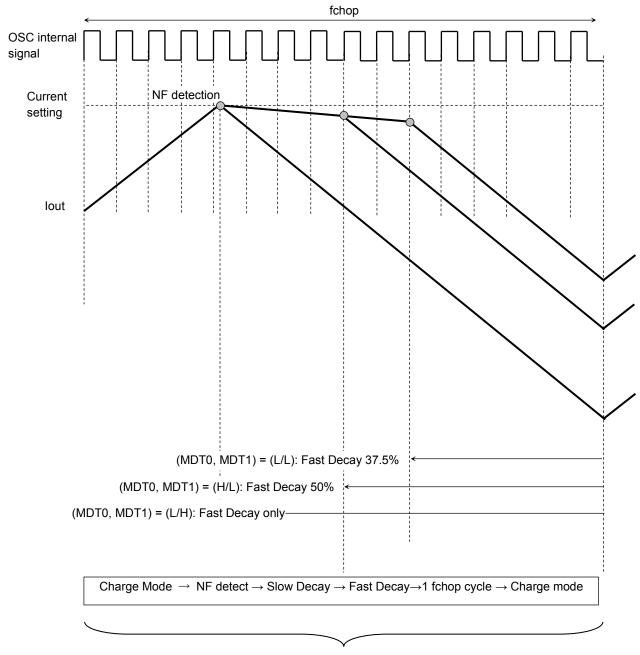
GAIN_SEL pin input	Function
L	Set Vref(gain) to 1/5
Н	Set Vref(gain) to 1/10

#### 8.13. Selectable Mixed Decay Function

The Selectable Mixed Decay can adjust the current regeneration amount during the period of current regeneration (Decay) using pins.

Though the Mixed Decay is determined by controlling 2 different types of decay (Fast Decay and Slow Decay), this function enables the user to select the ratio of the Mixed Decay using MDT0 and MDT1 pin. (2bit, 4 function)

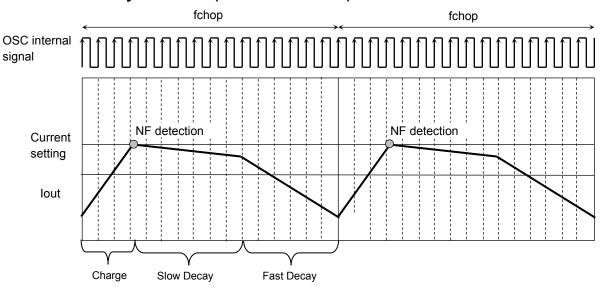
MDT1 pin input	MDT0 pin input	Function
L	L	Fast Decay: 37.5% (Fast Decay = OSCM × 6)
L	Н	Fast Decay: 50% (Fast Decay = OSCM × 8)
Н	L	Fast Decay only
Н	Н	ADMD



1 fchop cycle: OSCM × 16clock

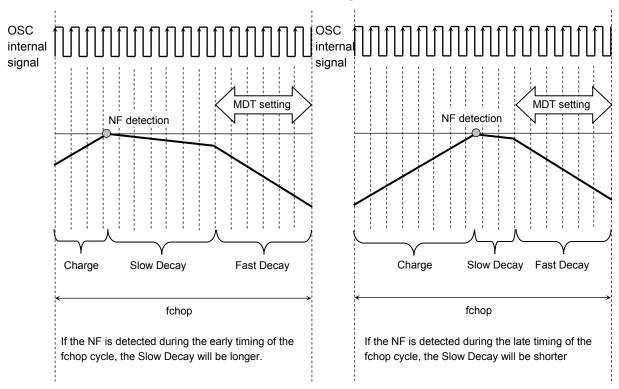
Note: Timing charts may be simplified for explanatory purpose.

#### 8.13.1. Mixed Decay Waveform (Current Waveform)



Note: Timing charts may be simplified for explanatory purpose.

#### 8.13.2. Constant Current PWM Function and Timings



The Charge period is determined by the operating status.

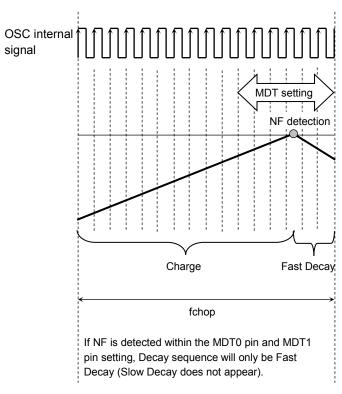
Therefore the NF detect timing with in the chopping cycle will change. If NF is detected in the early period of the fchop cycle, the Slow Decay will be longer. If NF is detected in the late period of the fchop cycle, the Slow Decay will be shorter, as shown above.

Note: The chopping cycle is determined as: fchop - (Charge + Fast decay) = Slow Decay

(Fast Decay ratio can be changed by MDT0 pin and MDT1 pin setting.)

Note: Timing charts may be simplified for explanatory purpose.

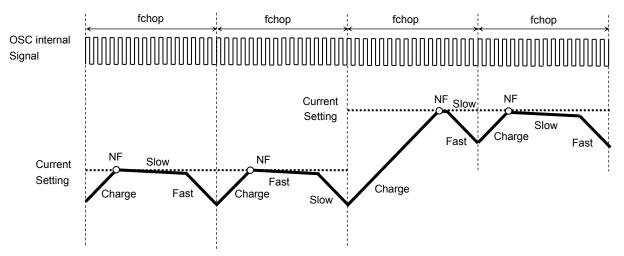
#### 8.13.3. Constant Current PWM Function and Timing



Note: Timing charts may be simplified for explanatory purpose.

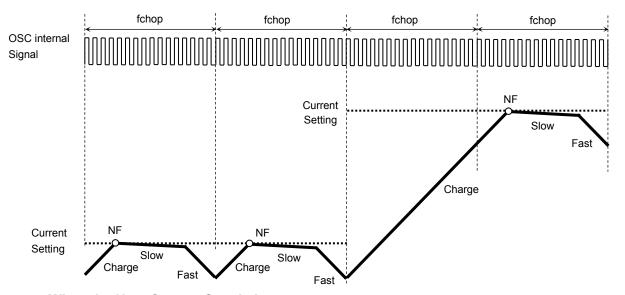
#### 8.13.4. Mixed Decay current waveform

#### When the next current step is higher:

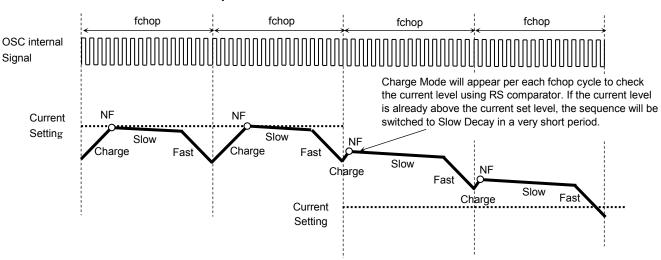


#### When Charge Period is More Than 1 fchop Cycle:

When the Charge period is longer than fchop cycle, the Charge period extends until the motor current reaches the NF threshold. Once the current reaches the next current step, then the sequence goes on to decay mode.



#### When the Next Current Step is Lower:

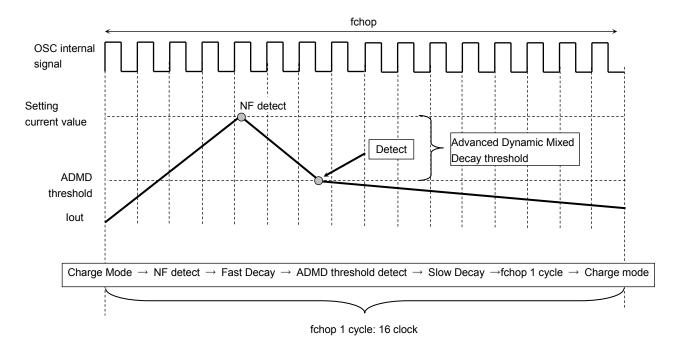


Note: Timing charts may be simplified for explanatory purpose.

# 8.13.5. ADMD (Advanced Dynamic Mixed Decay) Constant Current Control (MDT0 pin = H, MDT1 pin = H)

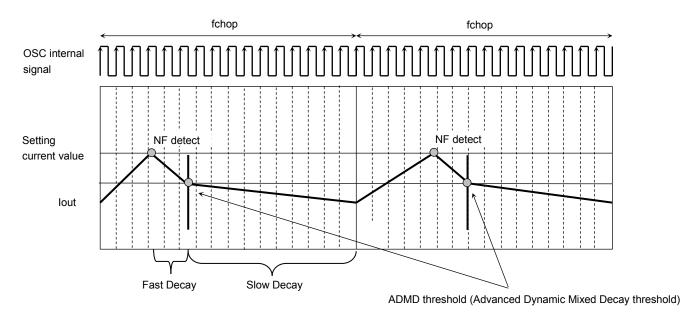
The TB5128FTG supports the Advanced Dynamic Mixed Decay (ADMD) which monitors both charge and discharge current during constant current PWM.

The basic sequence of the ADMD is as shown below.



Note: Timing charts may be simplified for explanatory purpose.

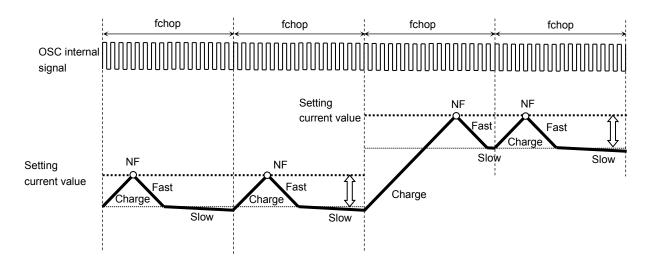
#### 8.13.5.1. Auto Decay Mode Current Waveform



Note: Timing charts may be simplified for explanatory purpose.

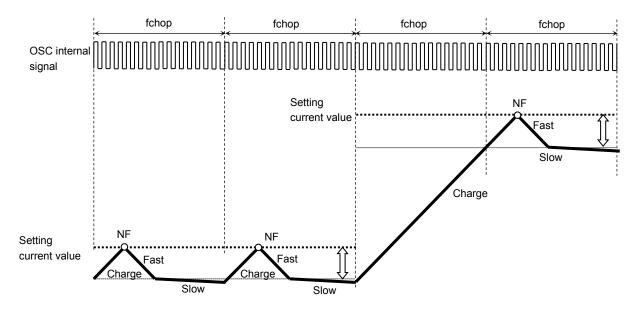
#### 8.13.5.2. Auto Decay Mode Current Waveform

#### • When the Next Current Step is Higher:



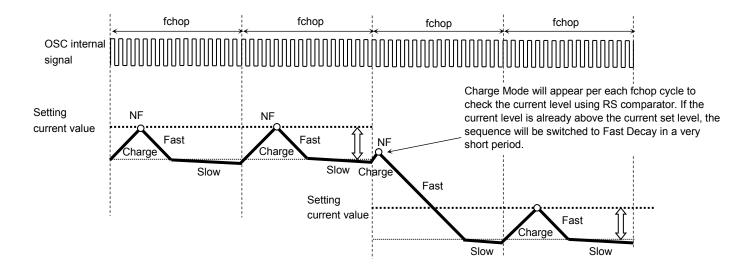
#### When Charge Period is More Than 1 fchop Cycle:

When the Charge period is longer than fchop cycle, the Charge period will be extended until the motor current reaches the NF threshold. Once the current reaches the next current step, then the sequence will go on to decay mode.

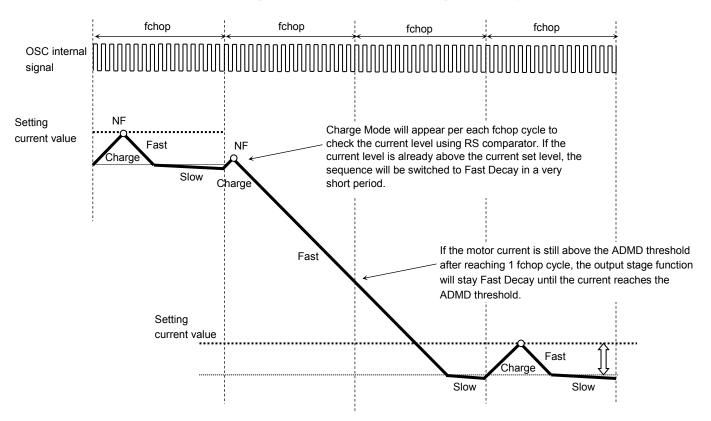


Note: Timing charts may be simplified for explanatory purpose.

#### When the Next Current Step is Lower:



#### When the Fast Continues Past 1 fchop Cycle (the motor current not reaching the ADMD threshold during 1 fchop cycle)

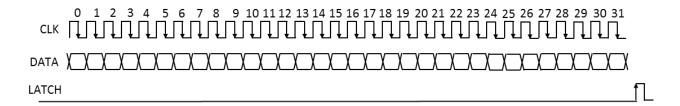


Note: Timing charts may be simplified for explanatory purpose.

## 9. Functional Description 2 (for Serial mode when IF\_SEL pin = H)

When IF\_SEL pin = H, the interface is serial input. It performs setting and motor control in the following 32 bit format.

When BANK\_EN pin is L, initial setting is performed. When the BANK\_EN pin is H, the motor is controlled. For the motor control, each current value is set in the serial setting, and the output is updated to the set current value at the timing of the LATCH signal.



BANK EN = L: Initial setting

D0	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15
0	0	0	0	0	0	0	0	0	0	0	0	RS_ SEL	GAIN _SEL	0	0
D16	D17	D18	D19	D20	D21	D22	D23	D24	D25	D26	D27	D28	D29	D30	D31

Note: The data which has a same name as a pin name in CLK mode performs as same as the pin in CLK mode.

BANK\_EN = H: Motor controlling

D0	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15
0	0	TOR QE0	TOR QE1	TOR QE2	0	MDT _A0	MDT _A1	PHA	CA0	CA1	CA2	CA3	CA4	CA5	CA6
D16	D17	D18	D19	D20	D21	D22	D23	D24	D25	D26	D27	D28	D29	D30	D31
CA7	CA8	CA9	MDT B0	MDT B1	PHB	CB0	CB1	CB2	CB3	CB4	CB5	CB6	CB7	CB8	CB9

Note: Every issuing a command, the current setting transfers by one step.

#### 9.1. Registers When BANK\_EN pin = H

The registers when BANK\_EN pin = H are shown below.

#### 9.1.1. PHx (x = A and B)

The polality of the output current can be selected by PHx register for each channels.

PHx register setting	Function
L	Setting the direction of the output current to minus
Н	Setting the direction of the output current to plus

#### 9.1.2. Cx0 to Cx9 (x = A or B)

The output of each channel's DAC for current limitation can be set by Cx0 to Cx9. The relation between Setting DAC and the output current (Iout) are shown below.

#### A) External Sense Resistor mode

$$\label{eq:lout_loud_section} \begin{aligned} \text{lout (max)} \ &= \ \text{Vref(gain)} \times \frac{\text{Vref(V)}}{\text{RS(\Omega)}} \times \frac{\text{Cx}[9:0]}{1023} \times \text{Setting torque by the torque function (\%)} \\ \text{(x = A or B)} \end{aligned}$$

#### B) RS Resistor Less Mode (ACDS)

$$\begin{split} & \text{Vref(gain)} = \frac{1}{5} \text{ (typ.) (when GAIN\_SEL pin = L)} \\ & \text{Iout (max)} = 1.56 \times \text{Vref (V)} \times \frac{\text{Cx[9:0]}}{1023} \times \text{Setting torque by the torque function (\%)} \\ & \text{Vref(gain)} = \frac{1}{10} \text{ (typ.) (when GAIN\_SEL pin= H)} \\ & \text{Iout (max)} = 0.78 \times \text{Vref (V)} \times \frac{\text{Cx[9:0]}}{1023} \times \text{Setting torque by the torque function (\%)} \\ & \text{(x = A or B)} \end{split}$$

#### 9.1.3. Torque function(D[2:4])

By using this terminal it is possible to switch the motor torque setting.

TORQE2	TORQE1	TORQE0	Function				
	0	0	Torque:100%				
0	O	1	Torque:85%				
	1	0	Torque:70%				
	1	'	·			1	Toque:60%
	0	0	Toque:50%				
1	U	1	Toque:40%				
'	1	0	Toque:25%				
	I	1	Toque:10%				

## 9.2. Serial setting example when driving a motor

Serial setting example for motor operation is shown below.

- 1. Set the BANK\_EN pin L. Initial setting is performed under this condition.
- 2. Then, set the BANK\_EN pin H and configure the motor control to turn on the output transistors.
- 3. Transmit the 1st to 4th commands repeatedly by keeping the BANK\_EN pin level H. The motor operates with full step resolution.

1st co	ommand														
D0	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15
0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
D16	D17	D18	D19	D20	D21	D22	D23	D24	D25	D26	D27	D28	D29	D30	D31
1	1	1	0	0	1	1	1	1	1	1	1	1	1	1	1
2nd c	omman	d													
D0	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15
0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1
D16	D17	D18	D19	D20	D21	D22	D23	D24	D25	D26	D27	D28	D29	D30	D31
1	1	1	0	0	1	1	1	1	1	1	1	1	1	1	1
3rd co	ommand														
D0	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15
0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1
					·										
D16	D17	D18	D19	D20	D21	D22	D23	D24	D25	D26	D27	D28	D29	D30	D31
1	1	1	0	0	0	1	1	1	1	1	1	1	1	1	1
4th co	ommand														
D0	D1	D2	D3	D4	D5	D6	D7	D8	D9	D10	D11	D12	D13	D14	D15
0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
D.10		D40	D.10	D00	D04	Doo	Doo	D04	D05	D00	D07	D00	D00	Doo	D04
D16	D17	D18	D19	D20	D21	D22	D23	D24	D25	D26	D27	D28	D29	D30	D31
1	1	1	0	0	0	1	1	1	1	1	1	1	1	1	1

## 10. Common Function (When CLK Mode and Serial Mode)

#### 10.1. LO (Error detect flag output) Function

When an error detection function performs, the LO function outputs an error detection as a signal from LO0 and LO1 pins to the outside of TB5128FTG.

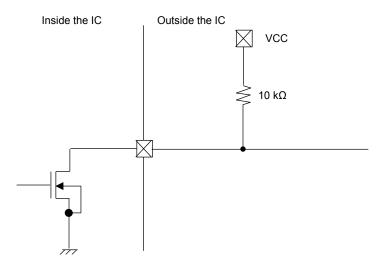
The LO0 and LO1 pins are open-drain output pins. The LO0 and LO1 pins need to be pulled up to VCC level via 10 k to 100 k $\Omega$  resistor.

During regular operation, the level of LO0 and LO1 pins will stay Hi-Z (the internal MOSFET is OFF, the level of these pins are VCC level).

When the thermal shutdown (TSD), Over current (ISD), or motor load open (OPD) occurs, the LO0 and/or LO1 pins will become L (the internal MOSFET is ON).

When the error detection is released by reasserting the VM power supply or setting the device to STANDBY mode, the LO0 and LO1 pins show "normal status".

Leave the LO0 and LO1 pins open when not using these functions.



Note: This figure may be simplified for explanatory purpose.

LO0 pin output	LO1 pin output	Function			
Hi-Z	Hi-Z	Normal status (Normal operation)			
Hi-Z	L	Detected motor load open (OPD)			
L	Hi-Z	Detected over current (ISD)			
L	L	Detected thermal shutdown (TSD)			

TSD and ISD are latch type. OPD will be of automatic return type.

#### 10.1.1 OPD Function

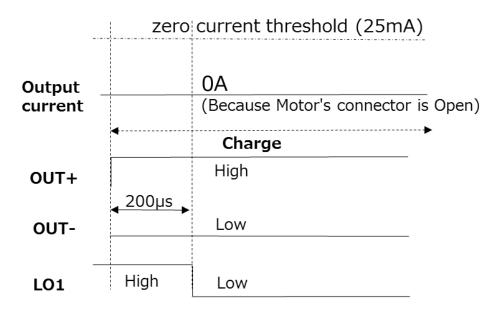
For the system, when the output current does not reach the zero current threshold (25mA) in the period of 200  $\mu$ s after Chrage starts, OPD is output.

Even when OPD works, Motor output does not stop and operation continues. Not standby mode.

The output is monitoring both Ach and Bch.

When using OPD, please judge it is open when LO1 is Low level for a certain period.

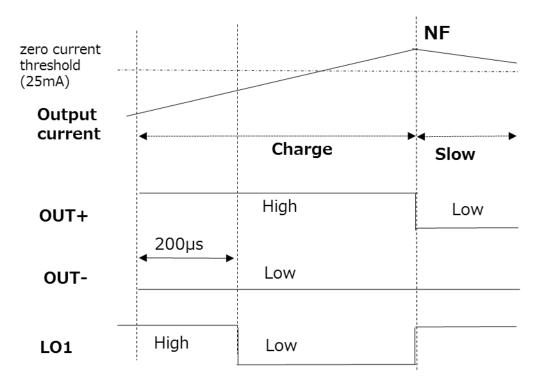
#### When Motor's connector is open



#### When the L value of Motor is large

Since the slope of the current is loose, it is detected as OPD.

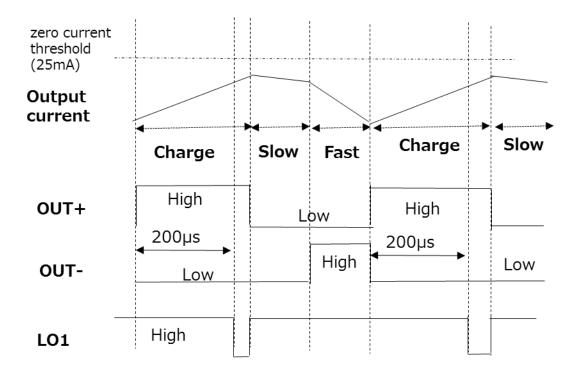
XThe timing to release OPD detection is Charge end after NF detection.



#### When the set current is small

Because the current setting is low, OPD detection works momentarily.

XThe timing to release OPD detection is Charge end after NF detection.



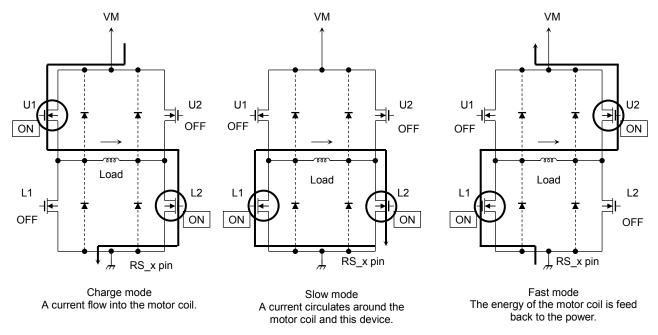
#### 10.2. STANDBY Function

It is possible to switch to Standby mode by switching this pin.

STANDBY pin input	Function
L	Standby mode
Н	Normal operation

Note: In STANDBY pin = L, an internal oscillating circuit and a motor output part are stopped. At this time, the motor cannot be driven.

## 11. Output Transistor Function Mode



Note: x = A or B

Note: The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

#### **Output transistor function**

MODE	U1	U2	L1	L2
CHARGE	ON	OFF	OFF	ON
SLOW	OFF	OFF	ON	ON
FAST	OFF	ON	ON	OFF

Note: This table shows an example of when the current flows as indicated by the arrows in the figures shown above. If the current flows in the opposite direction, refer to the following table.

MODE	U1	U2	L1	L2
CHARGE	OFF	ON	ON	OFF
SLOW	OFF	OFF	ON	ON
FAST	ON	OFF	OFF	ON

This IC controls the motor current to be constant by changing 3 modes listed above automatically.

#### 12. Calculation of the Predefined Output Current

#### 12.1. External Sense Resistor mode

For PWM constant-current control, this IC uses a clock generated by the OSCM oscillator.

The peak output current (Setting current value) can be set via the current-sensing resistor (RS) and the reference voltage (Vref), as follows:

$$Iout (max) = Vref(gain) \times \frac{Vref (V)}{RS (\Omega)}$$

Note: When GAIN\_SEL pin = L,  $Vref(gain) = \frac{1}{5}$  (typ.). And When GAIN\_SEL pin = H,  $Vref(gain) = \frac{1}{10}$  (typ.).

For example:

When Vref = 3.0 (V), RS = 0.22  $\Omega$ , Torque = 100% and Vref(gain) =  $\frac{1}{5}$  (typ.) (When GAIN\_SEL pin = L), motor constant current (Setting current value) will be calculated by the following expressions.

Iout (max) = 
$$\frac{1}{5} \times \frac{3 \text{ (V)}}{0.22 \text{ (}\Omega\text{)}} = 2.73 \text{ A}$$

#### 12.2. RS Resistor Less Mode (ACDS)

The Iout (max) will be calculated by the following expressions.

When 
$$Vref(gain) = \frac{1}{5}$$
 (typ.) (GAIN\_SEL = L)  
 $Iout (max) = 1.56 \times Vref (V)$ 

When 
$$Vref(gain) = \frac{1}{10}$$
 (typ.) (GAIN\_SEL = H)  
 $Iout (max) = 0.78 \times Vref (V)$ 

## Calculation of the OSCM Oscillation Frequency (chopper reference frequency)

An approximation of the OSCM oscillation frequency (fOSCM) and chopper frequency (fchop) can be calculated by the following expressions.

$$fOSCM = \frac{1}{0.56 \times \{COSC \times (ROSC + 500)\}}$$
$$fchop = \frac{fOSCM}{16}$$

Note: COSC: Capacitor connected to OSCM pin, ROSC: Resistor connected to OSCM pin

For example:

When COSC = 270 pF and  $ROSC = 5.1 \text{ k}\Omega$ , fOSCM frequency will be calculated by following expressions.

fOSCM = 
$$\frac{1}{0.56 \times \{270 \text{ pF} \times (5.1 \text{ k}\Omega + 500)\}} \approx 1.2 \text{ (MHz)(typ.)}$$
  
fchop =  $\frac{\text{fOSCM}}{16} = \frac{1.2 \text{ (MHz)}}{16} \approx 75 \text{ (kHz)}$ 

If chopping frequency is raised, Rippl of current will become small and wave-like reproducibility will improve. However, the gate loss inside IC goes up and generation of heat becomes large.

By lowering chopping frequency, reduction in generation of heat is expectable. However, Rippl of current may become large.

It is a standard about 70 kHz. A setup in the range of 50k to 100 kHz is recommended.

## 14. Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	Remarks
Motor output voltage	Vout	50	V	_
Motor power supply (non active)	\ /N /	50	V	STANDBY pin = L
Motor power supply (active)	VM	-0.4 to 44	V	STANDBY pin = H
Motor output current	lout	5.0	Α	(Note1)
	VCPP	VM ± 6 V	V	_
Charge pump voltage	VCPM	VM ± 6 V	V	_
	VCPO	50	V	_
Internal Logic power supply	VCC	6.0	V	When externally applied.
Lagia input valtaga	VIN(H)	6.0	V	_
Logic input voltage	VIN(L)	-0.4	V	_
MO output voltage	VMO	6.0	V	_
LO0, LO1 output voltage	VLO	6.0	V	_
MO Inflow current	IMO	6.0	mA	_
LO0, LO1 Inflow current	ILO	6.0	mA	_
Power dissipation	$P_{D}$	1.2	W	(Note2)
Operating temperature	Topr	-40 to 85	°C	_
Storage temperature	Tstg	-55 to 150	°C	_
Junction temperature	Tj(max)	150	°C	_

Note1: Usually, the maximum current value at the time should use 70% or less of the absolute maximum ratings for a standard on thermal rating. The maximum output current may be further limited in view of thermal considerations, depending on ambient temperature and board conditions.

Note2: Device alone (Ta =25°C)

When Ta exceeds 25°C, it is necessary to do the derating with 9.6 mW/°C.

Ta: Ambient temperature

Topr: Ambient temperature while the IC is active

Tj: Junction temperature while the IC is active. The maximum junction temperature is limited by the thermal shutdown (TSD) circuitry. It is advisable to keep the maximum current below a certain level so that the maximum junction temperature, Tj (MAX), will not exceed 120°C.

#### Caution) Absolute maximum ratings

The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.

Exceeding the rating (s) may cause device breakdown, damage or deterioration, and may result in injury by explosion or combustion.

The value of even one parameter of the absolute maximum ratings should not be exceeded under any circumstances. The TB5128FTG does not have overvoltage detection circuit. Therefore, the device is damaged if a voltage exceeding its rated maximum is applied.

All voltage ratings, including supply voltages, must always be followed. The other notes and considerations described later should also be referred to.

## 15. Operation Ranges (Ta=-40 to 85°C)

Characteristics	Symbol	Min	Тур.	Max	Unit	Remarks
Motor power supply	VM	6.5	24	44	V	_
Motor output current	lout	_	3.0	5.0	Α	(Note1)
	VIN(H)	2.0	_	5.5	V	Logic input H Level
Logic input voltage	VIN(L)	0	_	0.8	V	Logic input L Level
MO output pin voltage	VMO	_	3.3	5.0	V	_
LO0, LO1 output pin voltage	VLO	_	3.3	5.0	V	_
Clock input frequency	fCLK	_	_	200	kHz	_
Chopper frequency	fchop (range)	40	70	150	kHz	_
Vref input voltage	Vref	GND	2.0	3.6	V	_

Note1: Maximum current for actual usage may be limited by the operating circumstances such as operating conditions (exciting mode, operating time, and so on), ambient temperature, and heat conditions (board condition and so on).

## 16. Electrical Specifications 1 (Ta = 25°C, VM = 24 V, unless specified otherwise)

Characteristi	cs	Symbol	Test condition	Min	Тур.	Max	Unit
	HIGH	VIN(H) Logic input (Note1)		2.0	_	5.5	V
Logic input voltage	LOW	VIN(L)	Logic input (Note1)	0	_	0.8	V
Logic input hysteresis	s voltage	VIN(HYS)	Logic input (Note1)	100	_	300	mV
Logio input current	HIGH	IIN(H)	VIN(H) = 3.3 V	_	33	1	μA
Logic input current	LOW	IIN(L)	VIN(L) = 0 V	_	1	1	μA
MO output pin voltage	LOW	VOL(MO)	IOL = 5 mA, output = L	_	0.2	0.5	V
LO0, LO1 output pin voltage	LOW	VOL(LO)	IOL = 5 mA, output = L	_	0.2	0.5	V
		IM1	Output pins = open Standby mode	_	1.8	3.2	mA
Current consump	otion	IM2	Output pins = open ENABLE pin = L in releasing Standby mode	_	5.5	8.6	mA
		IM3	Output pins = open Full step resolution	_	8.2	10.4	mA
Output lookaga aurrant	High side	IOH	VM = 44 V, Vout = 0 V	_		1	μA
Output leakage current	Low side	IOL	VM = Vout = 44 V	1			μA
Motor current channel	differential	∆lout1	Current differential between Ch	-5	0	5	%
Motor current setting	accuracy	Δlout2	lout =3.0 A	-5	0	5	%
RS pin currer	nt	IRS	VRS = 0 V	0		10	μΑ
Motor output ON res (High side+Lows		Ron(H+L)	Tj = 25°C, High side+Low side	_	0.25	0.35	Ω

Note: When the logic signal is applied to the device whilst the VM power supply is not asserted; the device is designed not to function, but for safe usage, please apply the logic signal after the VM power supply is asserted and the VM voltage reaches the proper operating range.

Note1: VIN(H) is defined as the VIN voltage that causes the outputs (OUT\_A+ pin, OUT\_A- pin, OUT\_B+ pin, OUT\_B- pin) to change when a pin under test is gradually raised from 0 V.VIN(L) is defined as the VIN voltage that causes the outputs (OUT\_A+ pin, OUT\_A- pin, OUT\_B+ pin, OUT\_B- pin) to change when the pin is then gradually lowered. The difference between VIN(H) and VIN(L) is defined as the VIN(HYS).

# 17. Electrical Specifications 2 (Ta =25°C, VM = 24 V, unless specified otherwise)

Characteristics	Symbol	Test condition	Min	Тур.	Max	Unit
Vref input current	Iref	Vref = 2.0 V	_	0	1	μΑ
VCC voltage	VCC	ICC = 5.0 mA	4.75	5	5.25	V
VCC current	ICC	VCC = 5.0 V		2.5	5	mA
Vref gain rate	Vref(gain)	Vref = 2.0 V GAIN_SEL pin = L	1/5.2	1/5	1/4.8	_
Thermal shutdown (TSD) threshold (Note1)	TjTSD	_	145	160	175	°C
VM recovery voltage	VMR	_	5.7	6	6.3	V
Over current detection (ISD) threshold (Note2)	ISD	_	5.7	7.2	10	А

#### Note1: About TSD

When the junction temperature of the device reached the TSD threshold, the TSD circuit is triggered; the internal reset circuit then turns off the output transistors. Noise rejection blanking time is built-in to avoid misdetection. Once the TSD circuit is triggered, the device will be set to standby mode, and can be cleared by reasserting the VM power source, or setting the MODE pins to standby mode. The TSD circuit is a backup function to detect a thermal error, therefore is not recommended to be used aggressively.

#### Note2: About ISD

When the output current reaches the threshold, the ISD circuit is triggered; the internal reset circuit then turns off the output transistors. Once the ISD circuit is triggered, the device keeps the output off until power-on reset (POR), is reasserted or the device is set to standby mode by MODE pins. For fail-safe, please insert a fuse to avoid secondary trouble.

#### **Back-EMF**

While a motor is rotating, there is a timing at which power is fed back to the power supply. At that timing, the motor current recirculates back to the power supply due to the effect of the motor back-EMF.

If the power supply does not have enough sink capability, the power supply and output pins of the device might rise above the rated voltages. The magnitude of the motor back-EMF varies with usage conditions and motor characteristics. It must be fully verified that there is no risk that the TB5128FTG or other components will be damaged or fail due to the motor back-EMF.

#### Cautions on Overcurrent Shutdown (ISD) and Thermal Shutdown (TSD)

The ISD and TSD circuits are only intended to provide temporary protection against irregular conditions such as an output short-circuit; they do not necessarily quarantee the complete IC safety.

If the device is used beyond the specified operating ranges, these circuits may not operate properly: then the device may be damaged due to an output short-circuit.

The ISD circuit is only intended to provide a temporary protection against an output short-circuit. If such a condition persists for a long time, the device may be damaged due to overstress. Overcurrent conditions must be removed immediately by external hardware.

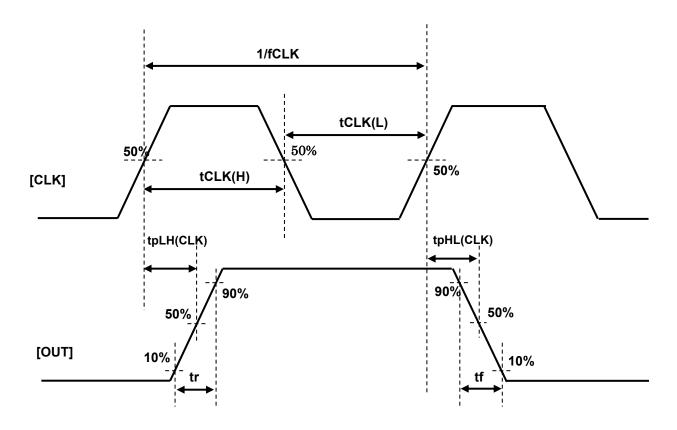
#### IC Mounting

Do not insert devices incorrectly or in the wrong orientation. Otherwise, it may cause breakdown, damage and/or deterioration of the device.

# 18. AC Electrical Specification (Ta = 25°C, VM = 24 V, 6.8 mH/5.7 $\Omega$ )

Characteristics	Symbol	Test condition	Min	Тур.	Max	Unit
Inside filter of CLK input minimum High width	tCLK(H)	The CLK(H) minimum pulse width	300	_	-	ns
Inside filter of CLK input minimum Low width	tCLK(L)	The CLK(L) minimum pulse width	250	_		ns
	tr		30	80	130	ns
Output transistor	tf		40	90	140	ns
switching specific	tpLH(CLK)	CLK output	1	1000		ns
	tpHL(CLK)	CLK output		1500		ns
Analog noise blanking time	AtBLK	VM = 24 V, lout = 3.0 A Analog tblank	250	400	550	ns
Oscillator frequency accuracy	ΔfOSCM	COSC = 270 pF, ROSC = 5.1 k $\Omega$	-15	_	+15	%
Oscillator reference frequency	fOSCM	COSC= 270 pF, ROSC =5.1 kΩ	1020	1200	1380	kHz
Chopping frequency	fchop	Output: Active (lout = 1.5 A), fOSC = 1200 kHz		75		kHz

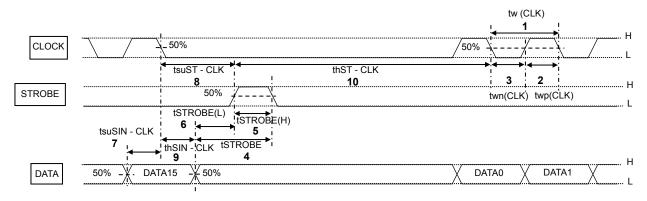
## **AC Electrical Specification Timing chart**



Note: Timing charts may be simplified for explanatory purpose.

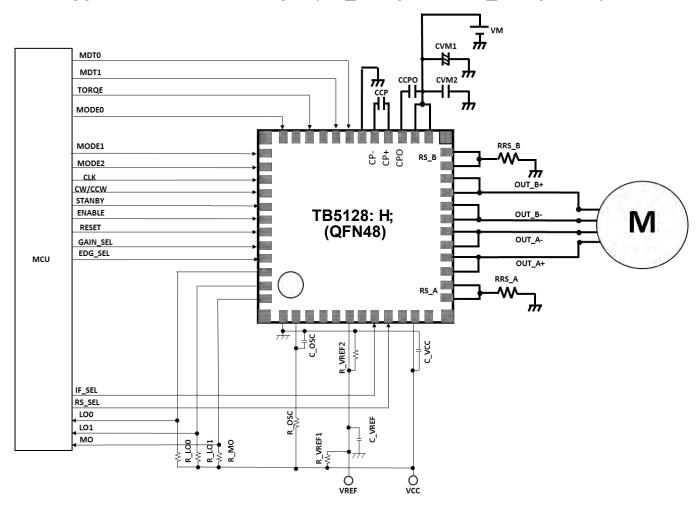
# 19. Other AC Electrical Specification (Ta = 25°C, VM = 24 V, unless specified otherwise)

Characteristics	Symbol	Test condition	Min	Тур.	Max	Unit	No. in Timing Chart
Serial CLK frequency	fSCLK	VIN = 3.3 V	1.0		25	MHz	_
CLK Cycle	tsCKW	VIH = 3.3 V, VIL = 0 V, tr = tf = 23 ns	46			ns	_
Minimum CLK pulse width	tw(CLK)	VIN = 3.3 V	40			ns	1
	twp(CLK)		20		1	ns	2
	twn(CLK)		20		ı	ns	3
Minimum STROBE pulse width	tSTROBE	VIN = 3.3 V	40		1	ns	4
	tSTROBE(H)		20		l	ns	5
	tSTROBE(L)		20	_	_	ns	6
Data setup time	tsuSIN - CLK	VIN = 3.3 V	10		1	ns	7
	tsuST - CLK		10			ns	8
Data hold time	thSIN - CLK	VIN = 3.3 V	10			ns	9
	thST - CLK		10	_	_	ns	10



Note: The CLK whose frequency is 1MHz or less may be used if the falling time and the rising time of CLK satisfy above condition.

## 20. Application Circuit Example (RS\_SEL pin = H, IF\_SEL pin = L)



The application circuit shown in this document is provided for reference purposes only. The data for mass production are not guaranteed.

Constant numbers of components (for reference only)

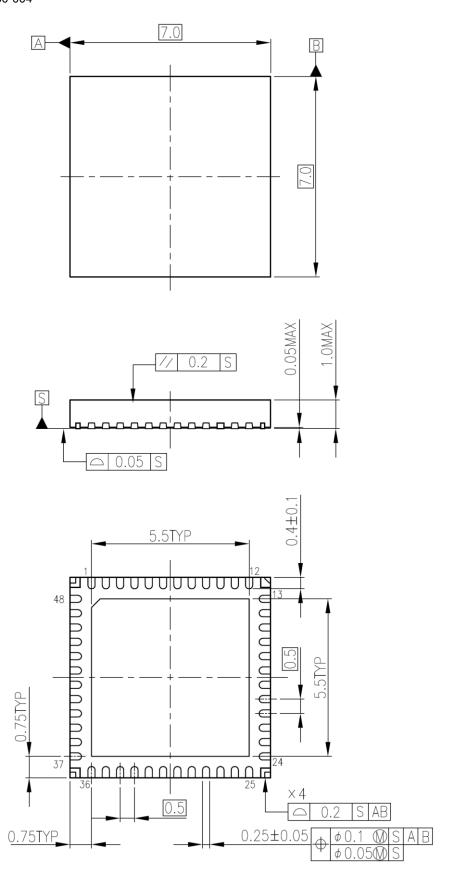
Part's symbol	Component	Reference constant number				
CVM1	Electrolytic capacitor	100 μF (CVM1 ≥ 10 μF)				
CVM2	Ceramic capacitor	(0.1 µF)				
CCP	Ceramic capacitor	0.022 μF				
ССРО	Ceramic capacitor	0.22 μF				
C_VCC	Ceramic capacitor	0.1 μF				
R_OSC	Resistor	5.1 kΩ (1.8 kΩ to 8.2 kΩ)				
C_OSC	Ceramic capacitor	270 pF				
R_VREF1, R_VREF2	Resistor	Arbitrary (10 k $\Omega \le R_VREF1 + R_VREF2 \le 50 k\Omega$ )				
C_VREF	Ceramic capacitor	(0.1 µF)				
R_MO	Resistor	10 kΩ (10 kΩ to 100 kΩ)				
R_LO0, R_LO1	Resistor	10 kΩ (10 kΩ to 100 kΩ)				

Note: Constant numbers in above table are for reference only. Some components outside of the recommendation range can be adopted depending on the usage conditions.

## 21. Package Dimensions

P-VQFN48-0707-0.50-004

Unit: mm



Weight: 0.14 g (typ.)

#### **Notes on Contents**

#### 1. Block Diagrams

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

#### 2. Equivalent Circuits

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

#### 3. Timing Charts

Timing charts may be simplified for explanatory purposes.

#### 4. Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially at the mass production design stage.

Providing these application circuit examples does not grant a license for industrial property rights.

#### 5. Test Circuits

Components in the test circuits are used only to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure from occurring in the application equipment.

#### IC Usage Considerations

#### Notes on handling of ICs

- (1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.
  Exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
- (2) Use an appropriate power supply fuse to ensure that a large current does not continuously flow in case of over current and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead smoke or ignition. To minimize the effects of the flow of a large current in case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- (3) If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition.

  Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- (4) Do not insert devices in the wrong orientation or incorrectly.

  Make sure that the positive and negative terminals of power supplies are connected properly.

  Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.

  In addition, do not use any device that is applied the current with inserting in the wrong orientation or incorrectly even just one time.
- (5) Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator.

  If there is a large amount of leakage current such as from input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure may cause smoke or ignition. (The overcurrent may cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection-type IC that inputs output DC voltage to a speaker directly.

#### Points to remember on handling of ICs

#### (1) Over current Protection Circuit

Over current protection circuits (referred to as current limiter circuits) do not necessarily protect ICs under all circumstances. If the Over current protection circuits operate against the over current, clear the over current status immediately.

Depending on the method of use and usage conditions, such as exceeding absolute maximum ratings can cause the over current protection circuit to not operate properly or IC breakdown before operation. In addition, depending on the method of use and usage conditions, if over current continues to flow for a long time after operation, the IC may generate heat resulting in breakdown.

#### (2) Thermal Shutdown Circuit

Thermal shutdown circuits do not necessarily protect ICs under all circumstances. If the thermal shutdown circuits operate against the over temperature, clear the heat generation status immediately. Depending on the method of use and usage conditions, such as exceeding absolute maximum ratings can cause the thermal shutdown circuit to not operate properly or IC breakdown before operation.

#### (3) Heat Radiation Design

In using an IC with large current flow such as power amp, regulator or driver, please design the device so that heat is appropriately radiated, not to exceed the specified junction temperature  $(T_j)$  at any time and condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, please design the device taking into considerate the effect of IC heat radiation with peripheral components.

#### (4) Back-EMF

When a motor rotates in the reverse direction, stops or slows down abruptly, a current flow back to the motor's power supply due to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond absolute maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.

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